

MSP650N240

N-Channel 650-V (D-S) MOSFET

Description

The device is using advanced Super-Junction technology. This advanced technology has been especially tailored to minimize conduction loss, provide superior switching performance and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for AC/DC power conversion in switching mode operation for higher efficiency.

Features

- 20A, 650V, $R_{DS(ON)typ} = 0.20\Omega @ V_{GS} = 10V$
- Low Gate Charge (typical 38nC)
- High Ruggedness
- Fast Switching
- 100% Avalanche Tested
- Improved dv/dt Capability

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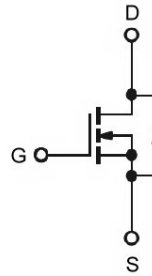
Typical Applications

- Switching Mode Power Supply
- Adapter / Charger
- Server Power

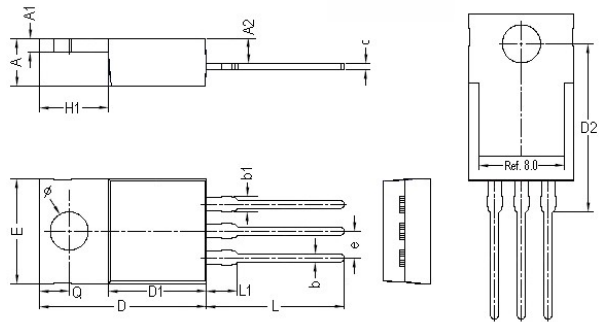
Package type : TO-220



Graphic Symbol



Package Dimension



REF.	Millimeter		REF.	Millimeter	
	Min.	Max.		Min.	Max.
A	4.30	4.70	D2	15.70	17.00
A1	1.20	1.40	E	9.70	10.36
A2	2.30	2.79	e	2.54 BSC	
b	0.70	0.90	H1	6.10	6.70
b1	1.20	1.75	L	12.80	13.90
c	0.34	0.60	L1	-	4.00
D	14.70	16.10	Q	2.60	3.00
D1	8.60	9.30	Ø	3.55	3.95

RoHS Compliant

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MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings			
Symbol	Parameter	Value	Units
V_{DS}	Drain-Source Voltage	650	V
V_{GS}	Gate-Source Voltage	± 30	V
I_D	Continuous Drain Current ¹ ($T_C = 25^\circ\text{C}$)	20	A
	Continuous Drain Current ¹ ($T_C = 100^\circ\text{C}$)	12	A
I_{DM}	Pulsed Drain Current ^{1,2}	80	A
I_{AS}	Single Pulse Avalanche Current, $L = 79\text{mH}^3$	4.2	A
E_{AS}	Single Pulse Avalanche Energy, $L = 79\text{mH}^3$	697	mJ
dv/dt	Peak Diode Recovery dv/dt	15	V/ns
P_D	Power Dissipation ⁴ ($T_C = 25^\circ\text{C}$)	227	W
	Derating Factor Above 25°C	1.8	W/ $^\circ\text{C}$
T_J/T_{STG}	Operating Junction and Storage Temperature	-55 to +150	$^\circ\text{C}$

Thermal Resistance Ratings			
Symbol	Parameter	Maximum	Units
$R_{\theta JA}$	Maximum Junction-to-Ambient ¹	62.5	$^\circ\text{C/W}$
$R_{\theta JC}$	Maximum Junction-to-Case ¹	0.55	$^\circ\text{C/W}$

Electrical Characteristics ($T_J = 25^\circ\text{C}$ unless otherwise specified)						
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	2.0	-	4.0	V
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{V}, I_D = 250\mu\text{A}$	650	-	-	V
$BV_{DSS} / \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250\mu\text{A}$, referenced to 25°C	-	0.69	-	V/ $^\circ\text{C}$
I_{GSS}	Gate-Source Leakage Current	$V_{DS} = 0\text{V}, V_{GS} = \pm 30\text{V}$	-	-	± 100	nA
I_{DSS}	Drain-Source Leakage Current	$V_{DS} = 650\text{V}, V_{GS} = 0\text{V}, T_C = 25^\circ\text{C}$	-	-	1	μA
		$V_{DS} = 520\text{V}, V_{GS} = 0\text{V}, T_C = 125^\circ\text{C}$	-	-	10	μA
$R_{DS(on)}$	Static Drain-Source On-Resistance	$V_{GS} = 10\text{V}, I_D = 10\text{A}$	-	0.2	0.24	Ω
R_g	Gate Resistance	$V_{GS} = V_{DS} = 0\text{V}, f = 1.0\text{MHz}$	-	2.2	-	Ω

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Dynamic						
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
Q _g	Total Gate Charge ²	V _{DS} = 520V	--	38	--	nC
Q _{gs}	Gate-Source Charge	I _D = 20A	--	9.0	--	
Q _{gd}	Gate-Drain Charge	V _{GS} = 10V	--	20	--	
t _{d(on)}	Turn-On Delay Time ²	V _{DS} = 325V	--	20	--	ns
t _r	Rise Time	I _D = 20A	--	56	--	
t _{d(off)}	Turn-Off Delay Time	V _{GS} = 10V	--	106	--	
t _f	Fall Time	R _G = 25Ω	--	41	--	
C _{iss}	Input Capacitance	V _{DS} = 100V	--	1197	--	pF
C _{oss}	Output Capacitance	V _{GS} = 0V	--	67	--	
C _{rss}	Reverse Transfer Capacitance	f = 1.0MHz	--	3.7	--	

Source-Drain Diode						
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
I _S	Continuous Source Current ^{1,5}	V _G = V _D = 0V, Force Current	-	-	20	A
I _{SM}	Pulsed Source Current ^{2,5}		-	-	80	
V _{SD}	Diode Forward Voltage ²	I _S = 20A, V _{GS} = 0V, T _J = 25°C	-	-	1.4	V
t _{rr}	Reverse Recovery Time ²	I _S = 20A, V _{GS} = 0V, dI _F / dt = 100A/μs		420		ns
Q _{rr}	Reverse Recovery Charge ²				6.1	

Notes

1. The data tested by surface mounted on a 1 inch² FR-4 board with 20Z copper.
2. The data tested by pulsed, pulse width ≤ 300us, duty cycle ≤ 2%.
3. The EAS data shows maximum rating. The test condition is V_{DD} = 100V, L = 79mH, I_{AS} = 4.2A.
4. The power dissipation is limited by 150°C junction temperature.
5. The data is theoretically the same as I_D and I_{DM}, in real applications, should be limited by total power dissipation.

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- Typical Electrical Characteristics

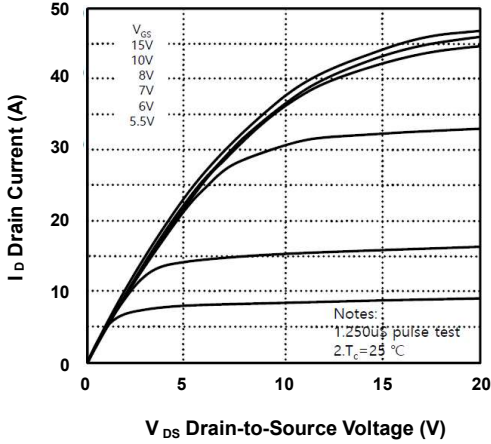


FIG.1-Typical Output Characteristics

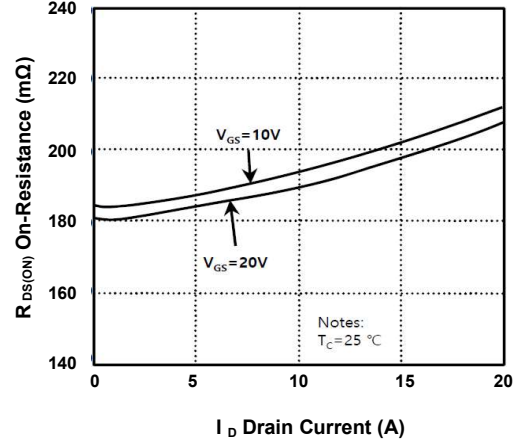


FIG.2-On-Resistance vs. Drain Current and V_{GS}

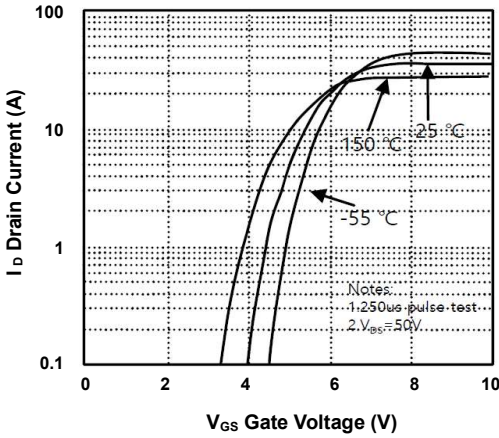


FIG.3-Transfer Characteristics

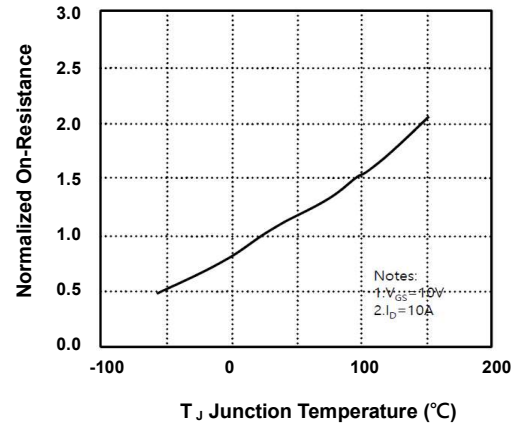


FIG.4-Normalized $R_{DS(on)}$ vs. T_J

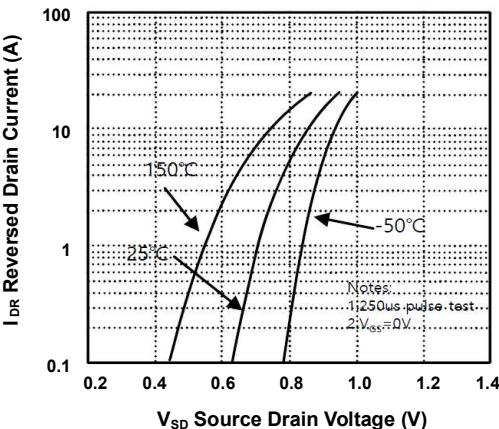


FIG.5-Body Diode Forward Voltage Variation

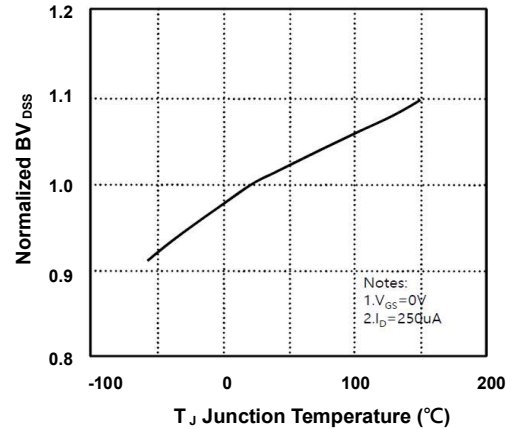
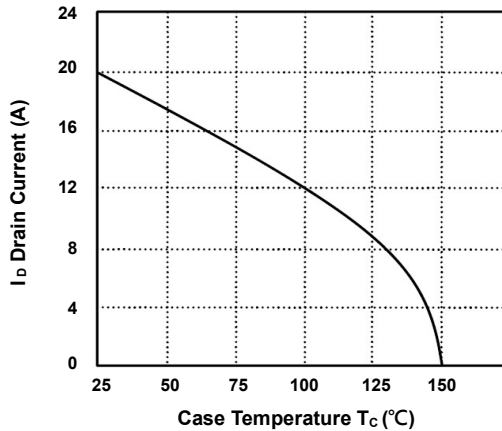
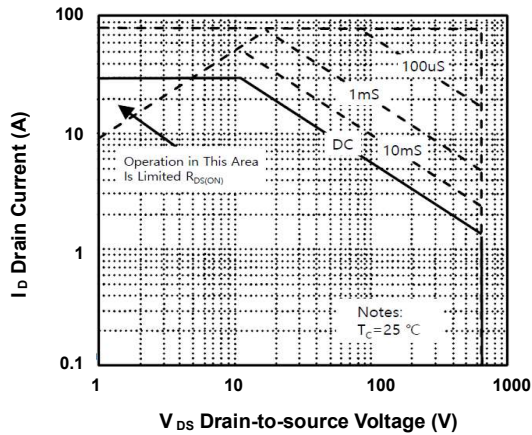
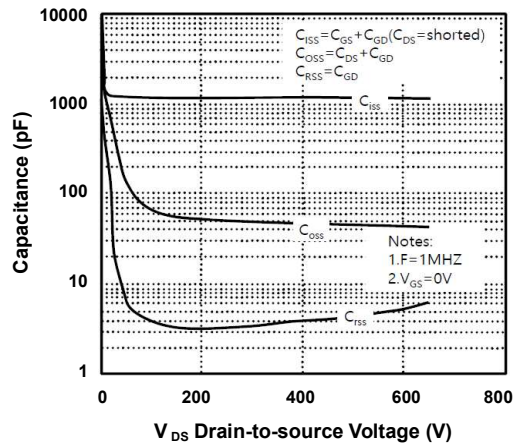
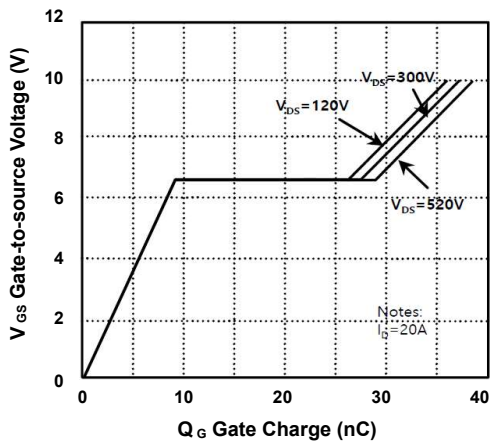


FIG.6-Breakdown Voltage Variation vs Temperature

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